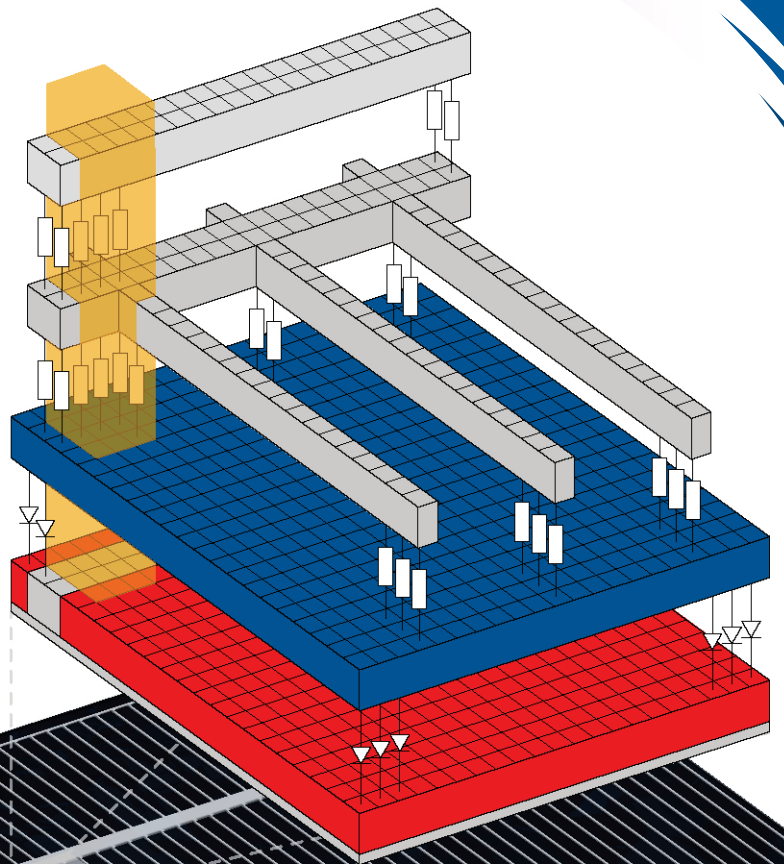
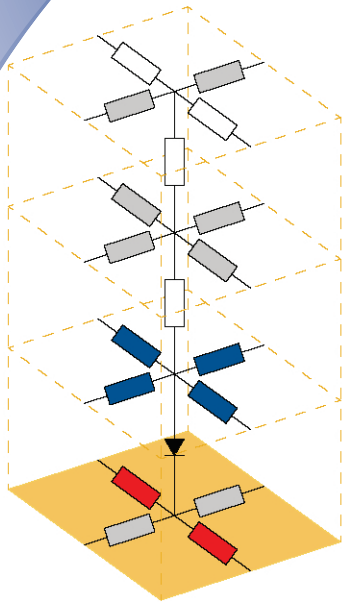


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MIDE M pri MIKROIKS

Stegne 11, 1521 Ljubljana, Slovenia

T. +386 (0)1 513 37 68

F. + 386 (0)1 513 37 71

E. info@midem-drustvo.si

www.midem-drustvo.si

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Editorial | Uvodnik

Dear reader,

Year 2019 ran out and this editorial brings up some statistics about manuscripts submitted in the previous year. In 2019 we received more than 110 manuscripts, out of which only 19 have been accepted for publication so far, while 22 were out of scope and 56 manuscripts were rejected. The number of manuscript submissions that are out of the journal's scope has been drastically reduced. The success rate remains below 20% in 2019 and reflects determination for quality that will path long-term quality growth. Citation metrics with JCR IF-2018=0.476, SNIP-2018=0.265 and CiteScore-2018=0,61 is an important performance indicator. In 2019 we published 26 original scientific papers and I sincerely thank all reviewers and Editorial Board Members for their valuable contribution to the journal.

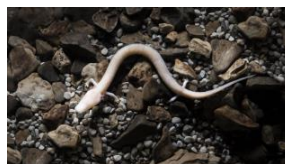
Year 2019 was also a milestone year for our journal. On 25 Sep 2019 our journal was accepted to the growing DOAJ family of open-access journals ([Informacije MIDEM – Journal of Microelectronics, Electronic Components and Materials](#)). Next to a digital object identifier (DOI) to all papers, the papers are accessible from WoS, Scopus or DOAJ by a single mouse click. We sincerely hope that the open-access papers will help us in wider dissemination and larger readership.

This issue marks another milestone. We have been publishing our journal for half of a century and it is my great honor and privilege to express gratitude to all, who served as editors, reviewers and authors of Informacije MIDEM – Journal of Microelectronics, Electronic Components and Materials in 49 volumes so far. Certainly, with this editorial we are starting the 50th volume and the 50th year of continuous publishing. As a part of your success in science and engineering we commit ourselves to continue serving you and look forward to receiving your future manuscript(s) on our submission page (<http://ojs.midem-drustvo.si/>).

Last but not least, do not let the covid-19 pandemic harm joy and peace in each home, office or research laboratory. Stay safe and healthy!

Prof. Marko Topič
Editor-in-Chief

31 March 2020



MIDEM 2020

56th INTERNATIONAL CONFERENCE ON MICROELECTRONICS, DEVICES AND MATERIALS
WITH THE WORKSHOP ON PERSONAL SENSOR FOR REMOTE HEALTH CARE MONITORING

September 30th – October 2nd, 2020
Hotel Jama, Postojna, Slovenia

Announcement and Call for Papers

Chairs:

Prof. Dr. Janez Trontelj (UL FE)
Doc. Dr. Aleksander Sešek (UL FE)

IMPORTANT DATES

Abstract submission deadline:
May 1, 2020

Acceptance notification:
June 15, 2020

Full paper submission deadline:
July 31, 2020

Invited and accepted papers will be published in the Conference Proceedings.

Detailed and updated information about the MIDEM Conferences, as well as for paper preparation can be found on

<http://www.midem-drustvo.si/>

GENERAL INFORMATION

The 56th International Conference on Microelectronics, Devices and Materials with the Workshop on Personal Sensor for Remote Health Care Monitoring continues a successful tradition of the annual international conferences organized by the MIDEM Society, the Society for Microelectronics, Electronic Components and Materials. The conference will be held at **Hotel Jama, Postojna, Slovenia**, well-known resort and conference centre, from **SEPTEMBER 30th – October 2nd, 2020**.

Topics of interest include but are not limited to:

- Workshop focus: Personal Sensor for Remote Health Care Monitoring,
- Novel monolithic and hybrid circuit processing techniques,
- New device and circuit design,
- Process and device modelling,
- Semiconductor physics,
- Sensors and actuators,
- Electromechanical devices, microsystems and nanosystems,
- Nanoelectronics,
- Optoelectronics,
- Photovoltaic devices,
- Electronic materials science and technology,
- New electronic materials and applications,
- Materials characterization techniques,
- Reliability and failure analysis,
- Education in microelectronics, devices and materials.

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MIDEM Society - Society for Microelectronics, Electronic Components and Materials, Slovenia

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